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### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	20
Program Memory Size	768B (512 x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	24 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 6.25V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16c55-xt-so">https://www.e-xfl.com/product-detail/microchip-technology/pic16c55-xt-so</a>

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- The Microchip Corporate Literature Center; U.S. FAX: (480) 792-7277

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# PIC16C5X

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NOTES:

# PIC16C5X

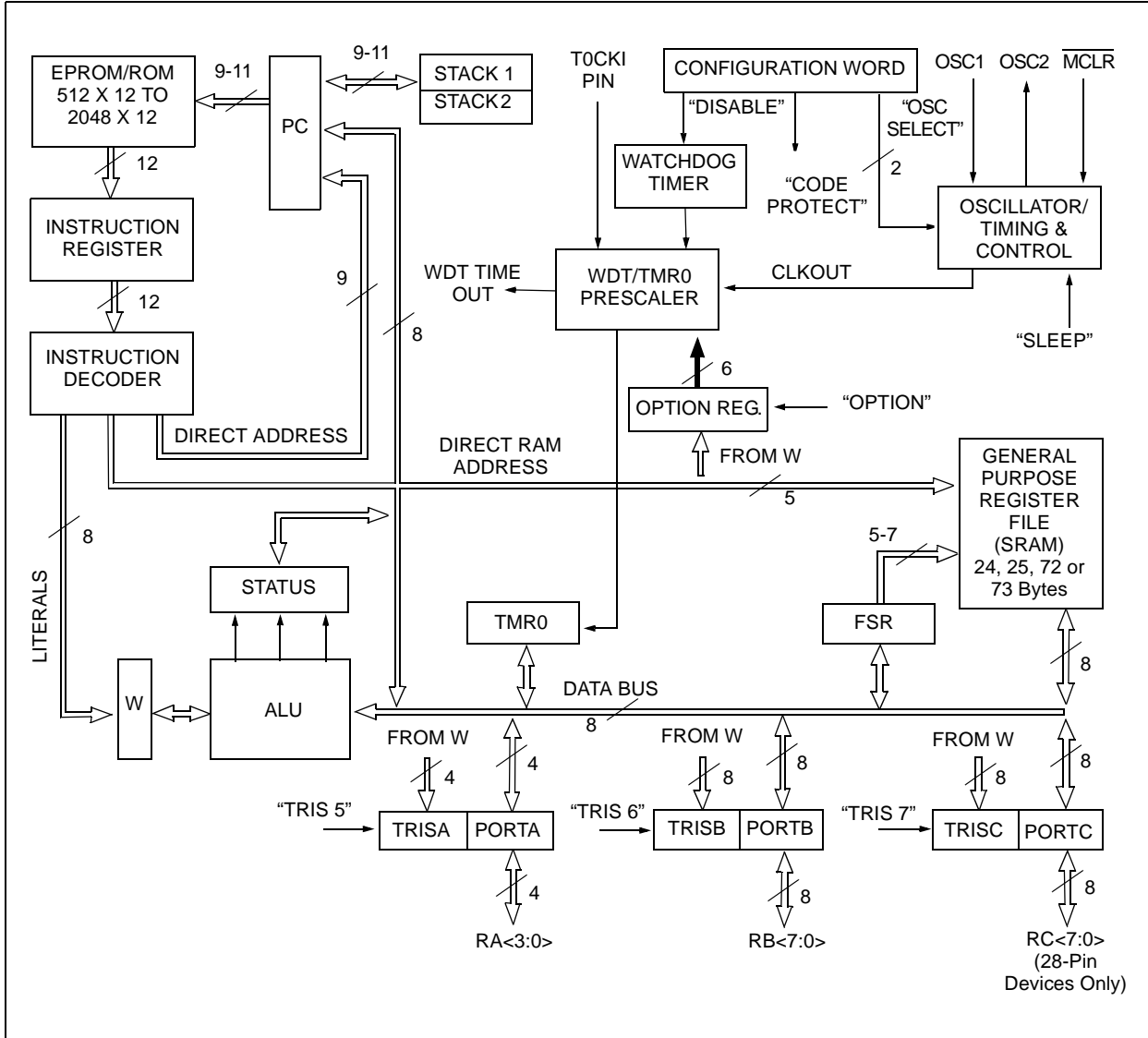
**TABLE 1-1: PIC16C5X FAMILY OF DEVICES**

Features	PIC16C54	PIC16CR54	PIC16C55	PIC16C56	PIC16CR56
Maximum Operation Frequency	40 MHz	20 MHz	40 MHz	40 MHz	20 MHz
EPROM Program Memory (x12 words)	512	—	512	1K	—
ROM Program Memory (x12 words)	—	512	—	—	1K
RAM Data Memory (bytes)	25	25	24	25	25
Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0
I/O Pins	12	12	20	12	12
Number of Instructions	33	33	33	33	33
Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin DIP, SOIC; 28-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP
All PIC® Family devices have Power-on Reset, selectable Watchdog Timer, selectable Code Protect and high I/O current capability.					

Features	PIC16C57	PIC16CR57	PIC16C58	PIC16CR58
Maximum Operation Frequency	40 MHz	20 MHz	40 MHz	20 MHz
EPROM Program Memory (x12 words)	2K	—	2K	—
ROM Program Memory (x12 words)	—	2K	—	2K
RAM Data Memory (bytes)	72	72	73	73
Timer Module(s)	TMR0	TMR0	TMR0	TMR0
I/O Pins	20	20	12	12
Number of Instructions	33	33	33	33
Packages	28-pin DIP, SOIC; 28-pin SSOP	28-pin DIP, SOIC; 28-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP
All PIC® Family devices have Power-on Reset, selectable Watchdog Timer, selectable Code Protect and high I/O current capability.				

# PIC16C5X

**FIGURE 3-1: PIC16C5X SERIES BLOCK DIAGRAM**



# PIC16C5X

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## 5.1 Power-On Reset (POR)

The PIC16C5X family incorporates on-chip Power-On Reset (POR) circuitry which provides an internal chip RESET for most power-up situations. To use this feature, the user merely ties the  $\overline{\text{MCLR}}/\text{VPP}$  pin to  $\text{VDD}$ . A simplified block diagram of the on-chip Power-On Reset circuit is shown in Figure 5-1.

The Power-On Reset circuit and the Device Reset Timer (Section 5.2) circuit are closely related. On power-up, the RESET latch is set and the DRT is RESET. The DRT timer begins counting once it detects  $\overline{\text{MCLR}}$  to be high. After the time-out period, which is typically 18 ms, it will RESET the reset latch and thus end the on-chip RESET signal.

A power-up example where  $\overline{\text{MCLR}}$  is not tied to  $\text{VDD}$  is shown in Figure 5-3.  $\text{VDD}$  is allowed to rise and stabilize before bringing  $\overline{\text{MCLR}}$  high. The chip will actually come out of reset  $\text{TDRT}$  msec after  $\overline{\text{MCLR}}$  goes high.

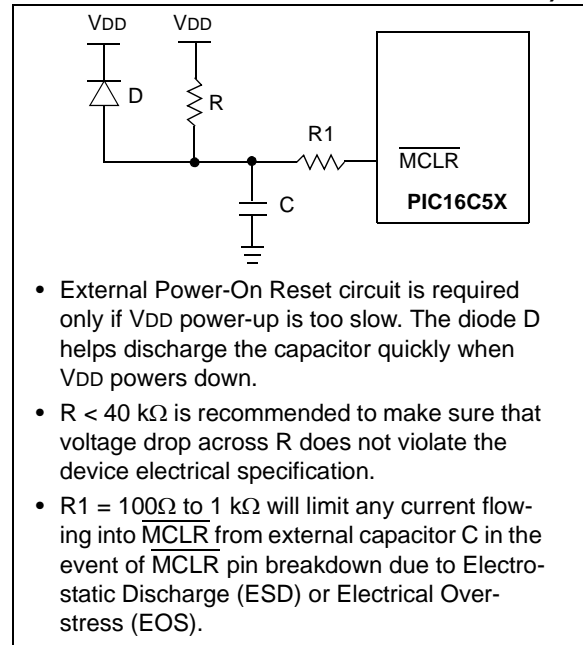
In Figure 5-4, the on-chip Power-On Reset feature is being used ( $\overline{\text{MCLR}}$  and  $\text{VDD}$  are tied together). The  $\text{VDD}$  is stable before the start-up timer times out and there is no problem in getting a proper RESET. However, Figure 5-5 depicts a problem situation where  $\text{VDD}$  rises too slowly. The time between when the DRT senses a high on the  $\overline{\text{MCLR}}/\text{VPP}$  pin, and when the  $\overline{\text{MCLR}}/\text{VPP}$  pin (and  $\text{VDD}$ ) actually reach their full value, is too long. In this situation, when the start-up timer times out,  $\text{VDD}$  has not reached the  $\text{VDD}(\text{min})$  value and the chip is, therefore, not guaranteed to function correctly. For such situations, we recommend that external RC circuits be used to achieve longer POR delay times (Figure 5-2).

**Note:** When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For more information on PIC16C5X POR, see *Power-Up Considerations - AN522* in the [Embedded Control Handbook](#).

The POR circuit does not produce an internal RESET when  $\text{VDD}$  declines.

**FIGURE 5-2: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW  $\text{VDD}$  POWER-UP)**



## 8.1 Using Timer0 with an External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock ( $T_{OSC}$ ) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

### 8.1.1 EXTERNAL CLOCK SYNCHRONIZATION

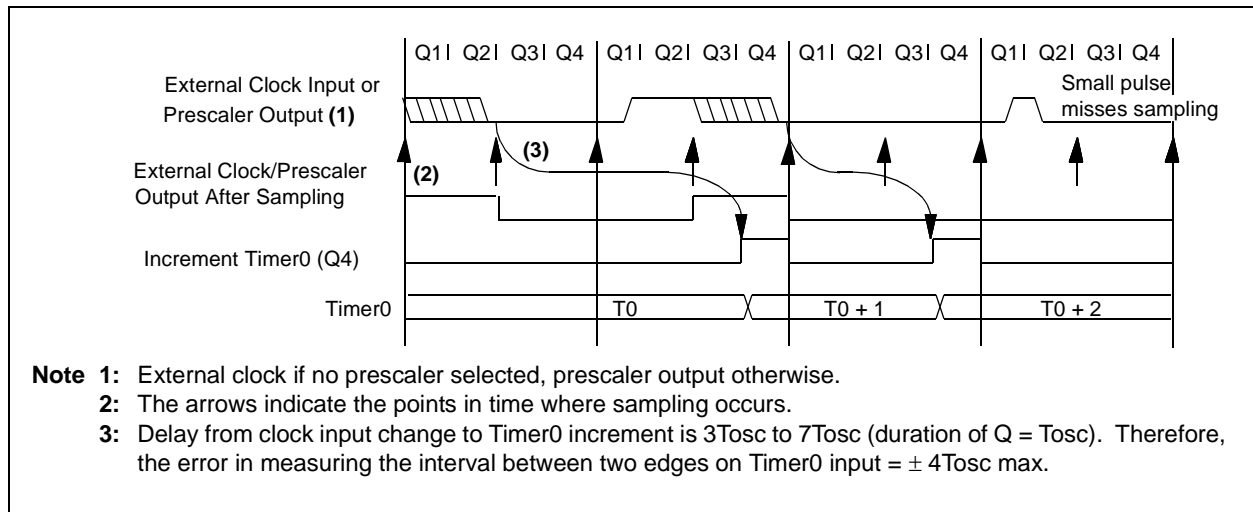
When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of  $T_{OCLK}$  with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 8-5). Therefore, it is necessary for  $T_{OCLK}$  to be high for at least  $2T_{OSC}$  (and a small RC delay of 20 ns) and low for at least  $2T_{OSC}$  (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

When a prescaler is used, the external clock input is divided by the asynchronous ripple counter-type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple counter must be taken into account. Therefore, it is necessary for  $T_{OCLK}$  to have a period of at least  $4T_{OSC}$  (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on  $T_{OCLK}$  high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

### 8.1.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 8-5 shows the delay from the external clock edge to the timer incrementing.

**FIGURE 8-5: TIMER0 TIMING WITH EXTERNAL CLOCK**





# PIC16C5X

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## 10.0 INSTRUCTION SET SUMMARY

Each PIC16C5X instruction is a 12-bit word divided into an OPCODE, which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16C5X instruction set summary in Table 10-2 groups the instructions into byte-oriented, bit-oriented, and literal and control operations. Table 10-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator is used to specify which one of the 32 file registers in that bank is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an 8 or 9-bit constant or literal value.

**TABLE 10-1: OPCODE FIELD DESCRIPTIONS**

Field	Description
f	Register file address (0x00 to 0x1F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0 (store result in W) d = 1 (store result in file register 'f') Default is d = 1
label	Label name
TOS	Top of Stack
PC	Program Counter
WDT	Watchdog Timer Counter
$\overline{TO}$	Time-out bit
$\overline{PD}$	Power-down bit
dest	Destination, either the W register or the specified register file location
[ ]	Options
( )	Contents
→	Assigned to
< >	Register bit field
∈	In the set of
<i>italics</i>	User defined term (font is courier)

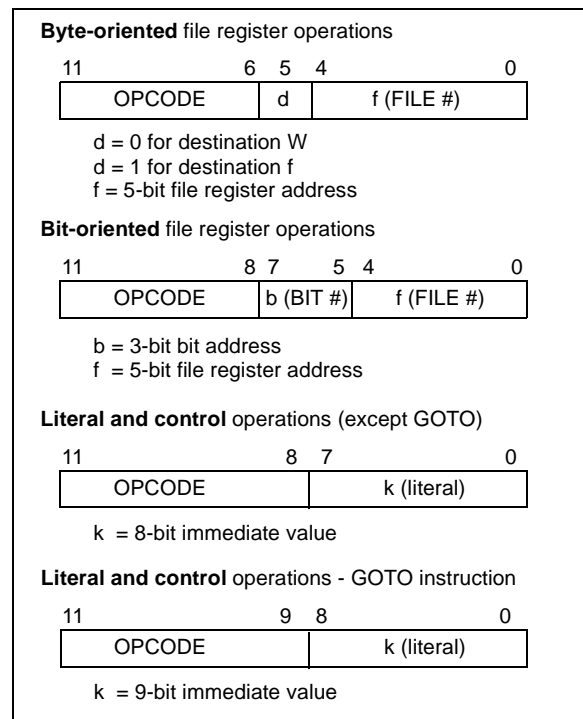
All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time would be 1 μs. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time would be 2 μs.

Figure 10-1 shows the three general formats that the instructions can have. All examples in the figure use the following format to represent a hexadecimal number:

0xhhh

where 'h' signifies a hexadecimal digit.

**FIGURE 10-1: GENERAL FORMAT FOR INSTRUCTIONS**



## 11.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers are supported with a full range of hardware and software development tools:

- Integrated Development Environment
  - MPLAB® IDE Software
- Assemblers/Compilers/Linkers
  - MPASM™ Assembler
  - MPLAB C17 and MPLAB C18 C Compilers
  - MPLINK™ Object Linker/  
MPLIB™ Object Librarian
- Simulators
  - MPLAB SIM Software Simulator
- Emulators
  - MPLAB ICE 2000 In-Circuit Emulator
  - ICEPIC™ In-Circuit Emulator
- In-Circuit Debugger
  - MPLAB ICD
- Device Programmers
  - PRO MATE® II Universal Device Programmer
  - PICSTART® Plus Entry-Level Development Programmer
- Low Cost Demonstration Boards
  - PICDEM™ 1 Demonstration Board
  - PICDEM 2 Demonstration Board
  - PICDEM 3 Demonstration Board
  - PICDEM 17 Demonstration Board
  - KEELOQ® Demonstration Board

### 11.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8-bit microcontroller market. The MPLAB IDE is a Windows®-based application that contains:

- An interface to debugging tools
  - simulator
  - programmer (sold separately)
  - emulator (sold separately)
  - in-circuit debugger (sold separately)
- A full-featured editor
- A project manager
- Customizable toolbar and key mapping
- A status bar
- On-line help

The MPLAB IDE allows you to:

- Edit your source files (either assembly or 'C')
- One touch assemble (or compile) and download to PIC MCU emulator and simulator tools (automatically updates all project information)
- Debug using:
  - source files
  - absolute listing file
  - machine code

The ability to use MPLAB IDE with multiple debugging tools allows users to easily switch from the cost-effective simulator to a full-featured emulator with minimal retraining.

### 11.2 MPASM Assembler

The MPASM assembler is a full-featured universal macro assembler for all PIC MCUs.

The MPASM assembler has a command line interface and a Windows shell. It can be used as a stand-alone application on a Windows 3.x or greater system, or it can be used through MPLAB IDE. The MPASM assembler generates relocatable object files for the MPLINK object linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, an absolute LST file that contains source lines and generated machine code, and a COD file for debugging.

The MPASM assembler features include:

- Integration into MPLAB IDE projects.
- User-defined macros to streamline assembly code.
- Conditional assembly for multi-purpose source files.
- Directives that allow complete control over the assembly process.

### 11.3 MPLAB C17 and MPLAB C18 C Compilers

The MPLAB C17 and MPLAB C18 Code Development Systems are complete ANSI 'C' compilers for Microchip's PIC17CXXX and PIC18CXXX family of microcontrollers, respectively. These compilers provide powerful integration capabilities and ease of use not found with other compilers.

For easier source level debugging, the compilers provide symbol information that is compatible with the MPLAB IDE memory display.

**TABLE 11-1: DEVELOPMENT TOOLS FROM MICROCHIP**

Tool	PIC12CXX	PIC1400	PIC16C5X	PIC16C6X	PIC16CXX	PIC16F62X	PIC16C7X	PIC16C7XX	PIC16C8X	PIC16F8XX	PIC16C9XX	PIC17C4X	PIC17C7XX	PIC18CXX2	PIC18FXX	24CXX/ 25CXX/ 93CXX	HCSXX	MCRFXX	MCP2510
<b>Software Tools</b>																			
MPLAB® Integrated Development Environment	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
MPLAB® C17 C Compiler																			
MPLAB® C18 C Compiler																			
MPASM™ Assembler/ MPLINK™ Object Linker	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
MPLAB® ICE In-Circuit Emulator	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
ICEPIC™ In-Circuit Emulator	✓		✓	✓	✓		✓	✓	✓	✓	✓								
<b>Debugger</b>																			
MPLAB® ICD In-Circuit Debugger				✓*			✓*			✓					✓				
<b>Programmers</b>																			
PICSTART® Plus Entry Level Development Programmer	✓	✓	✓	✓	✓	✓**	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
PRO MATE® II Universal Device Programmer	✓	✓	✓	✓	✓	✓**	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓
<b>Demo Boards and Eval Kits</b>																			
PICDEM™ 1 Demonstration Board			✓				†		✓										
PICDEM™ 2 Demonstration Board				†			†							✓					
PICDEM™ 3 Demonstration Board											✓								
PICDEM™ 14A Demonstration Board			✓																
PICDEM™ 17 Demonstration Board												✓							
KEELOQ® Evaluation Kit																	✓		
KEELOQ® Transponder Kit																	✓		
microID™ Programmer's Kit																		✓	
125 kHz microID™ Developer's Kit																		✓	
125 kHz Anticollision microID™ Developer's Kit																		✓	
13.56 MHz Anticollision microID™ Developer's Kit																		✓	
MCP2510 CAN Developer's Kit																		✓	✓

\* Contact the Microchip Technology Inc. web site at [www.microchip.com](http://www.microchip.com) for information on how to use the MPLAB® ICD In-Circuit Debugger (DV164001) with PIC16C62, 63, 64, 65, 72, 73, 74, 76, 77.

\*\* Contact Microchip Technology Inc. for availability date.

† Development tool is available on select devices.

**TABLE 12-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C54/55/56/57**

Standard Operating Conditions (unless otherwise specified)							
AC Characteristics							
Operating Temperature      0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended							
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
1	TOSC	External CLKIN Period <sup>(1)</sup>	250	—	—	ns	XT osc mode
			100	—	—	ns	10 MHz mode
			50	—	—	ns	HS osc mode (Comm/Ind)
			62.5	—	—	ns	HS osc mode (Ext)
			25	—	—	µs	LP osc mode
		Oscillator Period <sup>(1)</sup>	250	—	—	ns	RC osc mode
			250	—	10,000	ns	XT osc mode
			100	—	250	ns	10 MHz mode
			50	—	250	ns	HS osc mode (Comm/Ind)
			62.5	—	250	ns	HS osc mode (Ext)
25	—	—	µs	LP osc mode			
2	Tcy	Instruction Cycle Time <sup>(2)</sup>	—	4/Fosc	—	—	
3	TosL, TosH	Clock in (OSC1) Low or High Time	85*	—	—	ns	XT oscillator
			20*	—	—	ns	HS oscillator
			2.0*	—	—	µs	LP oscillator
4	TosR, TosF	Clock in (OSC1) Rise or Fall Time	—	—	25*	ns	XT oscillator
			—	—	25*	ns	HS oscillator
			—	—	50*	ns	LP oscillator

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

**2:** Instruction cycle period (Tcy) equals four times the input oscillator time base period.

# PIC16C5X

## 13.2 DC Characteristics: PIC16CR54A-04E, 10E, 20E (Extended)

PIC16CR54A-04E, 10E, 20E (Extended)			Standard Operating Conditions (unless otherwise specified) Operating Temperature $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
D001	VDD	<b>Supply Voltage</b>					
		RC, XT and LP modes	3.25	—	6.0	V	
		HS mode	4.5	—	5.5	V	
D002	VDR	<b>RAM Data Retention Voltage</b> <sup>(1)</sup>	—	1.5*	—	V	Device in SLEEP mode
D003	VPOR	<b>VDD Start Voltage</b> to ensure Power-on Reset	—	VSS	—	V	See Section 5.1 for details on Power-on Reset
D004	SVDD	<b>VDD Rise Rate</b> to ensure Power-on Reset	0.05*	—	—	V/ms	See Section 5.1 for details on Power-on Reset
D010	IDD	<b>Supply Current</b> <sup>(2)</sup>					
		RC <sup>(3)</sup> and XT modes	—	1.8	3.3	mA	FOSC = 4.0 MHz, VDD = 5.5V
		HS mode	—	4.8	10	mA	FOSC = 10 MHz, VDD = 5.5V
		HS mode	—	9.0	20	mA	FOSC = 16 MHz, VDD = 5.5V
D020	IPD	<b>Power-down Current</b> <sup>(2)</sup>	—	5.0	22	μA	VDD = 3.25V, WDT enabled
			—	0.8	18	μA	VDD = 3.25V, WDT disabled

\* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

**Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.

a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

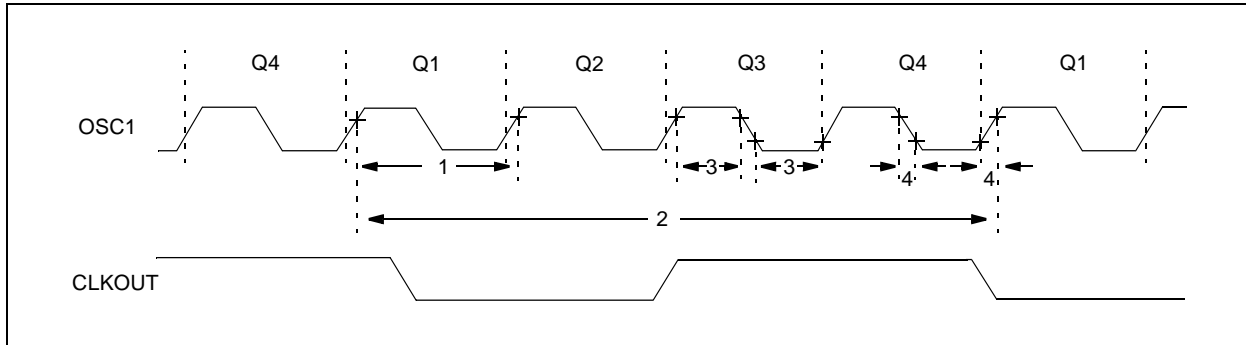
b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

**3:** Does not include current through REXT. The current through the resistor can be estimated by the formula:  $I_R = V_{DD}/2R_{EXT}$  (mA) with REXT in kΩ.

# PIC16C5X

## 13.6 Timing Diagrams and Specifications

**FIGURE 13-2: EXTERNAL CLOCK TIMING - PIC16CR54A**



**TABLE 13-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16CR54A**

Standard Operating Conditions (unless otherwise specified)								
AC Characteristics								
Operating Temperature								
0°C ≤ TA ≤ +70°C for commercial								
-40°C ≤ TA ≤ +85°C for industrial								
-40°C ≤ TA ≤ +125°C for extended								
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions	
	FOSC	External CLKIN Frequency <sup>(1)</sup>	DC	—	4.0	MHz	XT osc mode	
			DC	—	4.0	MHz	HS osc mode (04)	
			DC	—	10	MHz	HS osc mode (10)	
			DC	—	20	MHz	HS osc mode (20)	
			DC	—	200	kHz	LP osc mode	
			Oscillator Frequency <sup>(1)</sup>	DC	—	4.0	MHz	RC osc mode
				0.1	—	4.0	MHz	XT osc mode
				4.0	—	4.0	MHz	HS osc mode (04)
				4.0	—	10	MHz	HS osc mode (10)
				4.0	—	20	MHz	HS osc mode (20)
		5.0	—	200	kHz	LP osc mode		

\* These parameters are characterized but not tested.

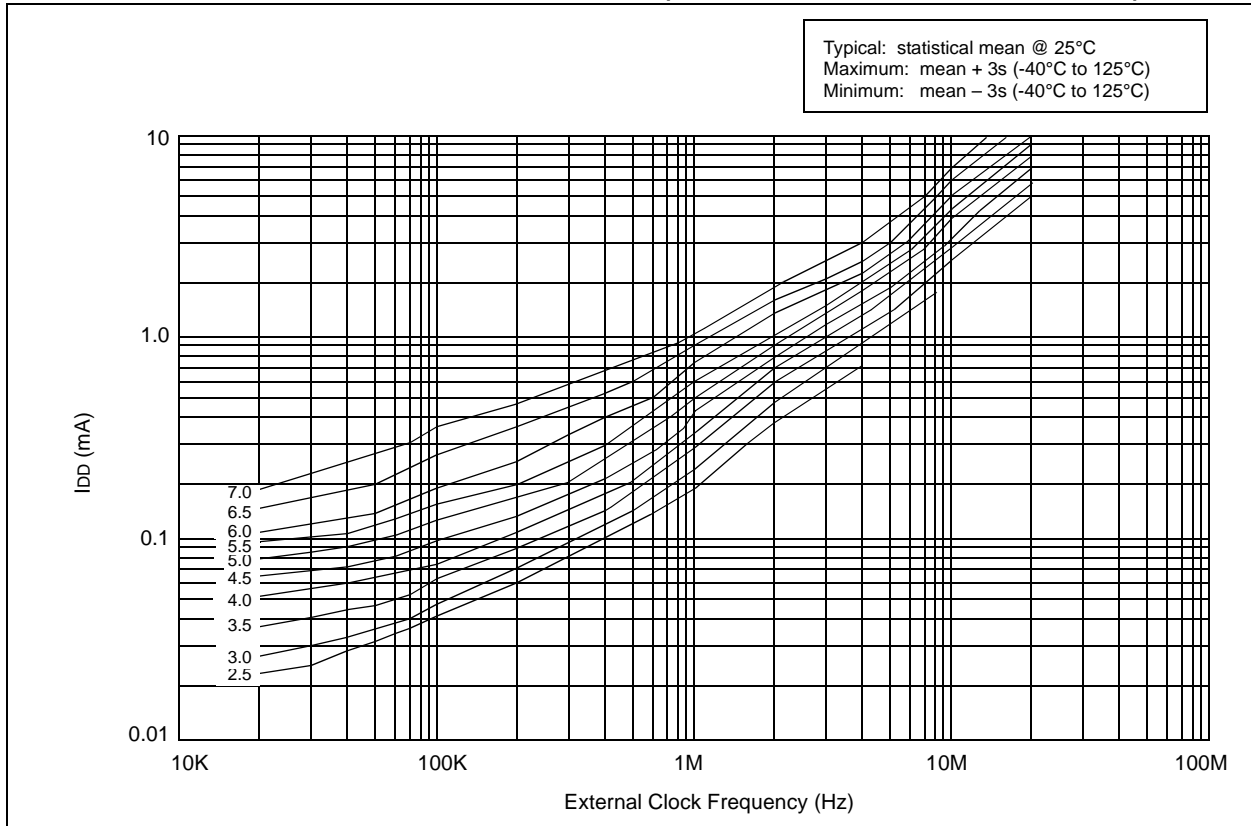
† Data in the Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

**Note 1:** All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

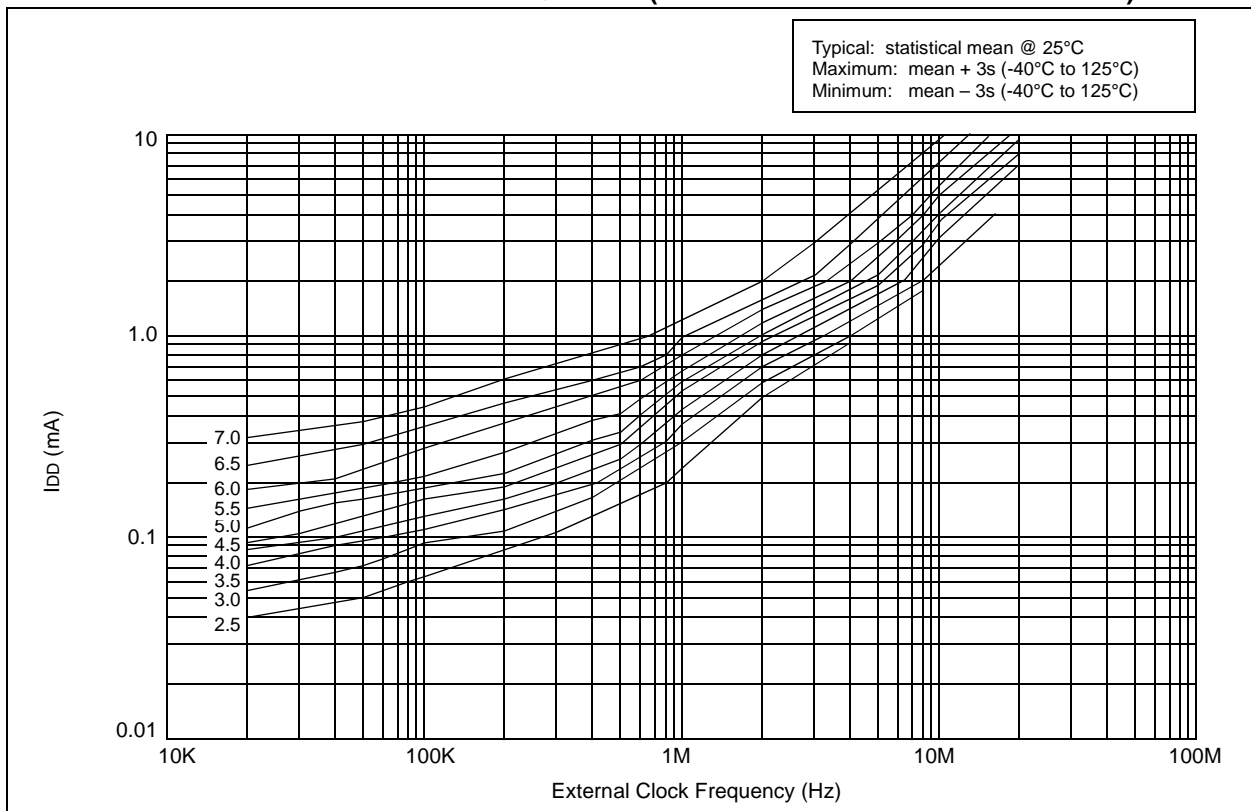
When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

**2:** Instruction cycle period (Tcy) equals four times the input oscillator time base period.

**FIGURE 14-13: MAXIMUM IDD VS. FREQUENCY (EXTERNAL CLOCK, -40°C TO +85°C)**



**FIGURE 14-14: MAXIMUM IDD vs. FREQUENCY (EXTERNAL CLOCK -55°C TO +125°C)**





# PIC16C5X

## 15.5 Timing Parameter Symbology and Load Conditions

The timing parameter symbols have been created with one of the following formats:

1. TppS2ppS
2. TppS

T	F Frequency	T Time
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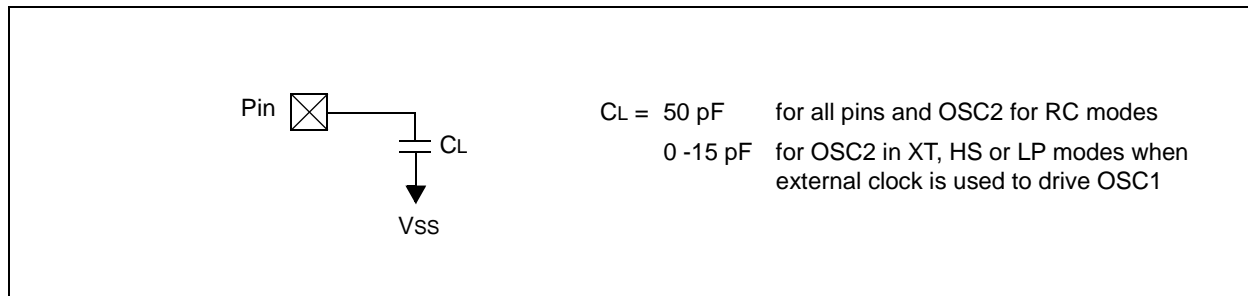
Lowercase letters (pp) and their meanings:

pp	2 to	mc $\overline{\text{MCLR}}$
ck	CLKOUT	osc oscillator
cy	cycle time	os OSC1
drt	device reset timer	t0 T0CKI
io	I/O port	wdt watchdog timer

Uppercase letters and their meanings:

S	F Fall	P Period
	H High	R Rise
	I Invalid (Hi-impedance)	V Valid
	L Low	Z Hi-impedance

**FIGURE 15-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS - PIC16C54A**



# PIC16C5X

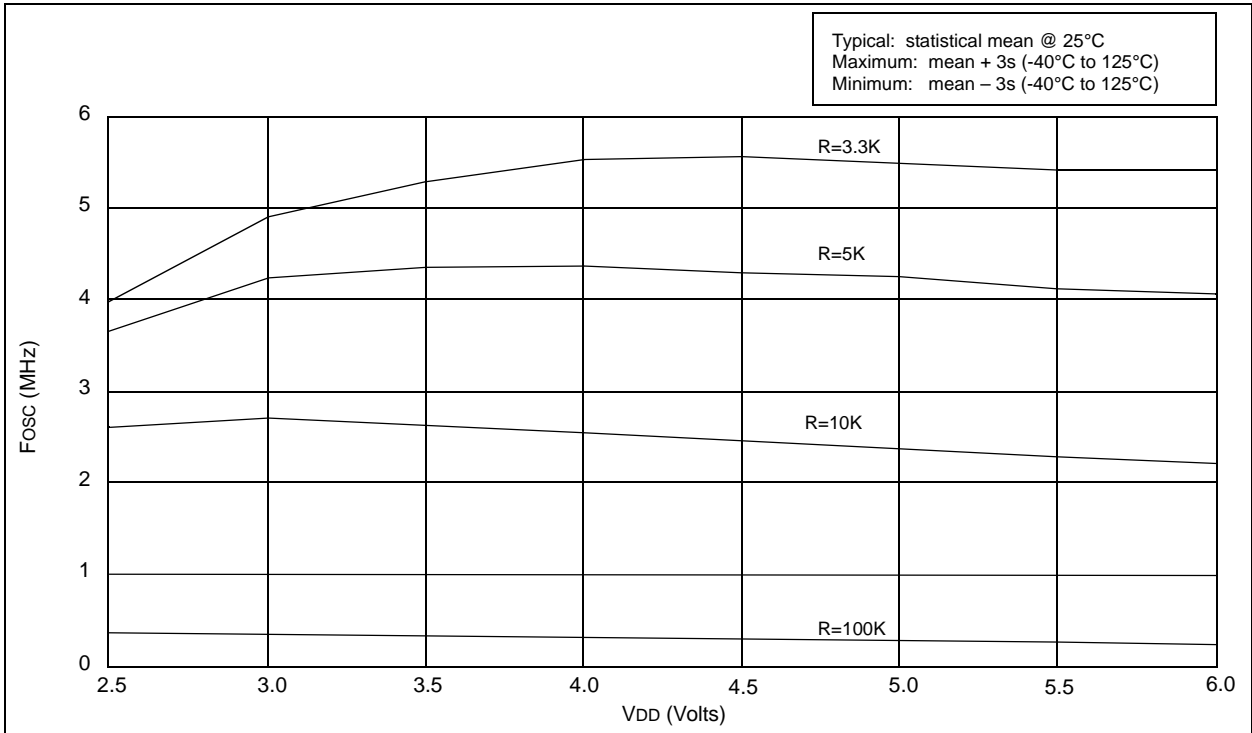
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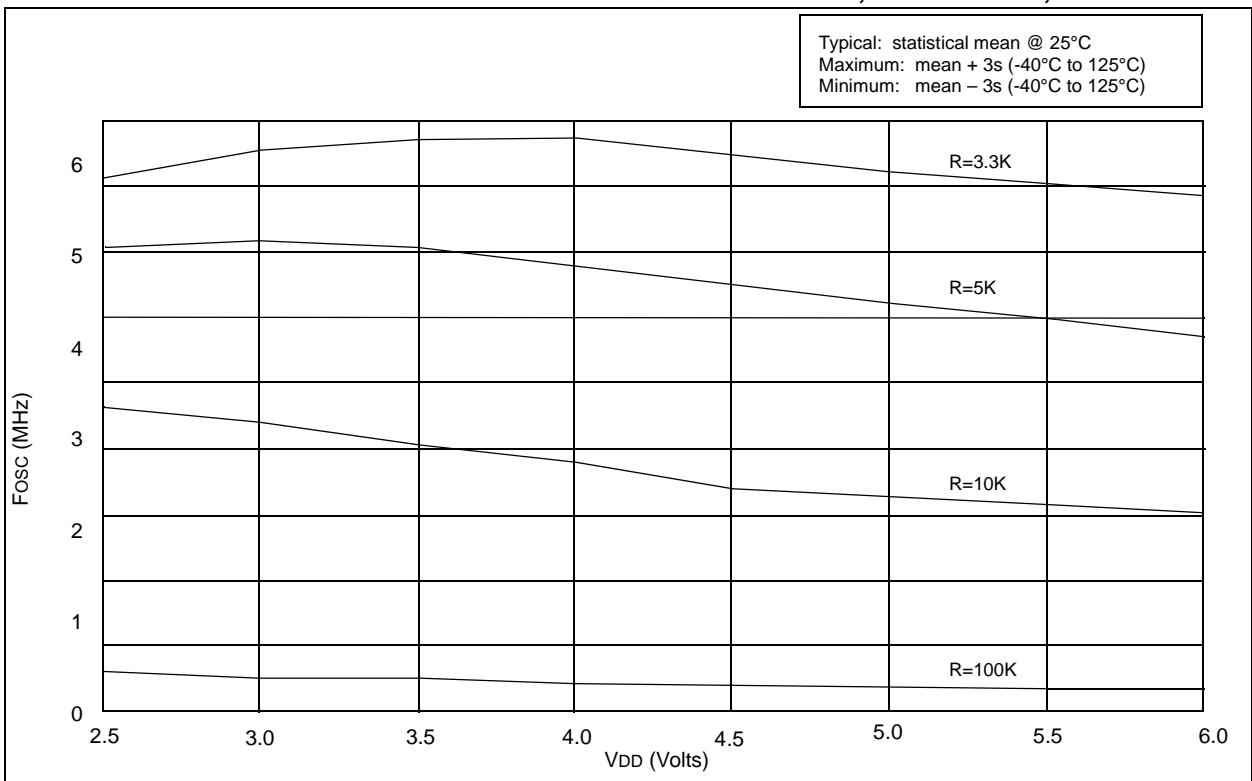
NOTES:

# PIC16C5X

**FIGURE 16-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 20 pF, 25°C**



**FIGURE 16-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD, CEXT = 100 pF, 25°C**



# PIC16C5X

## 17.1 DC Characteristics: PIC16C54C/C55A/C56A/C57C/C58B-04, 20 (Commercial, Industrial) PIC16LC54C/LC55A/LC56A/LC57C/LC58B-04 (Commercial, Industrial) PIC16CR54C/CR56A/CR57C/CR58B-04, 20 (Commercial, Industrial) PIC16LCR54C/LCR56A/LCR57C/LCR58B-04 (Commercial, Industrial)

PIC16LC5X PIC16LCR5X (Commercial, Industrial)		Standard Operating Conditions (unless otherwise specified) Operating Temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial					
PIC16C5X PIC16CR5X (Commercial, Industrial)		Standard Operating Conditions (unless otherwise specified) Operating Temperature 0°C ≤ TA ≤ +70°C for commercial -40°C ≤ TA ≤ +85°C for industrial					
Param No.	Symbol	Characteristic/Device	Min	Typ†	Max	Units	Conditions
D020	IPD	Power-down Current <sup>(2)</sup>					
		PIC16LC5X	—	0.25	2	μA	VDD = 2.5V, WDT disabled, Commercial
			—	0.25	3	μA	VDD = 2.5V, WDT disabled, Industrial
			—	1	5	μA	VDD = 2.5V, WDT enabled, Commercial
—	1.25		8	μA	VDD = 2.5V, WDT enabled, Industrial		
D020A	IPD	PIC16C5X	—	0.25	4.0	μA	VDD = 3.0V, WDT disabled, Commercial
			—	0.25	5.0	μA	VDD = 3.0V, WDT disabled, Industrial
			—	1.8	7.0*	μA	VDD = 5.5V, WDT disabled, Commercial
			—	2.0	8.0*	μA	VDD = 5.5V, WDT disabled, Industrial
			—	4	12*	μA	VDD = 3.0V, WDT enabled, Commercial
			—	4	14*	μA	VDD = 3.0V, WDT enabled, Industrial
			—	9.8	27*	μA	VDD = 5.5V, WDT enabled, Commercial
			—	12	30*	μA	VDD = 5.5V, WDT enabled, Industrial

Legend: Rows with standard voltage device data only are shaded for improved readability.

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

**Note 1:** This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

**Note 2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.

a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

**Note 3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in kΩ.

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